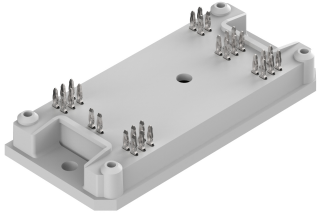
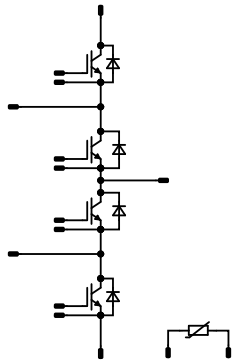




| <i>flow</i> BUCK-BOOST 1 | | 650 V / 150 A | |
|--|--|--|--|
| Features <ul style="list-style-type: none">• BatteryBuck Boost• IGBT S5 + Rapid1S• fsw 20-50kHz• NTC | | flow 1 12 mm housing  | |
| Target applications <ul style="list-style-type: none">• Power Supply• UPS | | Schematic  | |
| Types <ul style="list-style-type: none">• 10-PY07BBA150S5-M735L58Y | | | |



Vincotech

10-PY07BBA150S5-M735L58Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------------------------------|------------|---------------------------------------|----------|------|
| Boost Switch | | | | |
| Collector-emitter voltage | V_{CES} | | 650 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 105 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 450 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 145 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Boost Diode

| | | | | |
|---------------------------------|------------|---------------------------------------|-----|----|
| Peak repetitive reverse voltage | V_{RRM} | | 650 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 70 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 200 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 95 | W |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Buck Switch

| | | | | |
|-----------------------------------|------------|---------------------------------------|----------|----|
| Collector-emitter voltage | V_{CES} | | 650 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 48 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 150 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 73 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | °C |



Vincotech

10-PY07BBA150S5-M735L58Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|---------------------------------|------------|---------------------------------------|-------|------|
| Buck Diode | | | | |
| Peak repetitive reverse voltage | V_{RRM} | | 650 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 41 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 80 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 58 | W |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{jop} | | -40...+($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|------------|-------------------------------------|-------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 6000 | V |
| Isolation voltage | V_{isol} | AC Voltage $t_p = 1\text{ min}$ | 2500 | V |
| Creepage distance | | | >12,7 | mm |
| Clearance | | | 8,11 | mm |
| Comparative Tracking Index | CTI | | ≥ 200 | |

*100 % tested in production



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|--------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Boost Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|-------------------|----|-----|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0015 | 25 | 3,2 | 4 | 4,8 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 150 | 25 125 150 | | 1,43 1,52 1,55 | 1,75 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 650 | | 25 | | | 100 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{ies} | | | | | | | 9000 | | pF |
| Output capacitance | C_{oes} | $f = 1$ Mhz | 0 | 25 | | 25 | | 260 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 34 | | pF |
| Gate charge | Q_g | $V_{CC} = 520$ V | 15 | | 150 | 25 | | 328 | | nC |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,65 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|--|--|--|--|------------------|--|------------------------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | | | | | 25 125 150 | | 31 32 31 | | ns |
| Rise time | t_r | | | | | 25 125 150 | | 11 12 12 | | ns |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 125 150 | | 152 172 178 | | ns |
| Fall time | t_f | | | | | 25 125 150 | | 9,45 15,64 18,76 | | ns |
| Turn-on energy (per pulse) | E_{on} | $Q_{tFWD} = 4,23$ μC $Q_{tFWD} = 7,61$ μC $Q_{tFWD} = 8,42$ μC | | | | 25 125 150 | | 1,34 1,78 1,78 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 125 150 | | 1,19 1,92 2,15 | | mWs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|--|-------------------|--|---|-------------------------------------|------------------|------------------|---------------------------|---------------------|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |
| Boost Diode | | | | | | | | | | |
| Static | | | | | | | | | | |
| Forward voltage | V_F | | | 100 | 25 125 150 | | 1,61 1,58 1,57 | 1,92 ⁽¹⁾ | | V |
| Reverse leakage current | I_R | $V_r = 650$ V | | | 25 | | | 5,3 | | μA |
| Thermal | | | | | | | | | | |
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | 1 | | | K/W |
| Dynamic | | | | | | | | | | |
| Peak recovery current | I_{RRM} | | | | 25 125 150 | | 150,93 185,65 192,3 | | | A |
| Reverse recovery time | t_{rr} | | | | 25 125 150 | | 52,09 80,98 89,45 | | | ns |
| Recovered charge | Q_r | $di/dt=10473$ A/μs $di/dt=9230$ A/μs $di/dt=9328$ A/μs | 0/15 | 350 | 126 | 25 125 150 | 4,23 7,61 8,42 | | | μC |
| Reverse recovered energy | E_{rec} | | | | 25 125 150 | | 1,08 2,01 2,23 | | | mWs |
| Peak rate of fall of recovery current | $(di_r/dt)_{max}$ | | | | 25 125 150 | | 7084 3185 3380 | | | A/μs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|--------|-----|-----|------|
| | | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | |

Buck Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|-------------------|----|-----|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0005 | 25 | 3,2 | 4 | 4,8 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 50 | 25 125 150 | | 1,39 1,48 1,51 | 1,75 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 650 | | 25 | | | 50 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 100 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{ies} | | | | | | | 3100 | | pF |
| Output capacitance | C_{oes} | $f = 1$ Mhz | 0 | 25 | | 25 | | 88 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 12 | | pF |
| Gate charge | Q_g | $V_{CC} = 520$ V | 15 | | 50 | 25 | | 120 | | nC |

Thermal

| | | | | | | | | | | |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 1,29 | | K/W |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|--|--|--|--|------------------|--|-------------------------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | | | | | 25 125 150 | | 25,6 32 32 | | ns |
| Rise time | t_r | | | | | 25 125 150 | | 7,4 11 10 | | ns |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 125 150 | | 125,8 145 152 | | ns |
| Fall time | t_f | | | | | 25 125 150 | | 10,58 25,4 32,6 | | ns |
| Turn-on energy (per pulse) | E_{on} | $Q_{tFWD} = 1,86$ μC $Q_{tFWD} = 3,21$ μC $Q_{tFWD} = 3,63$ μC | | | | 25 125 150 | | 0,613 0,722 0,758 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 125 150 | | 0,505 0,786 0,887 | | mWs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|--|-------------------|---|---|-------------------------------------|------------------|------------------|-------------------------|---------------------|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |
| Buck Diode | | | | | | | | | | |
| Static | | | | | | | | | | |
| Forward voltage | V_F | | | 40 | 25 125 150 | | 1,51 1,44 1,42 | 1,92 ⁽¹⁾ | | V |
| Reverse leakage current | I_R | $V_r = 650$ V | | | 25 | | | 2,1 | | μA |
| Thermal | | | | | | | | | | |
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | 1,63 | | | K/W |
| Dynamic | | | | | | | | | | |
| Peak recovery current | I_{RRM} | | | | 25 125 150 | | 62,04 75,39 80,48 | | | A |
| Reverse recovery time | t_{rr} | | | | 25 125 150 | | 59,3 87,23 96,59 | | | ns |
| Recovered charge | Q_r | $di/dt=6192$ A/μs $di/dt=5422$ A/μs $di/dt=5179$ A/μs | 0/15 | 400 | 50 | 25 125 150 | 1,86 3,21 3,63 | | | μC |
| Reverse recovered energy | E_{rec} | | | | 25 125 150 | | 0,461 1,08 1,22 | | | mWs |
| Peak rate of fall of recovery current | $(di_r/dt)_{max}$ | | | | 25 125 150 | | 1550 1357 1542 | | | A/μs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|------------|--------|-----|-----|------|
| | | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | V_{CE} [V] | T_j [°C] | Min | Typ | Max | |

Thermistor

Static

| | | | | | | | | | | |
|--------------------------------|----------------|-------------------------|--|--|--|-----|----|------|---|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R_{100} | $A_{R/R}$ | $R_{100} = 1484 \Omega$ | | | | 100 | -5 | | 5 | % |
| Power dissipation | P | | | | | | | 5 | | mW |
| Power dissipation constant | d | | | | | 25 | | 1,5 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. $\pm 1 \%$ | | | | | | 3962 | | K |
| B-value | $B_{(25/100)}$ | Tol. $\pm 1 \%$ | | | | | | 4000 | | K |
| Vincotech Thermistor Reference | | | | | | | | | I | |

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

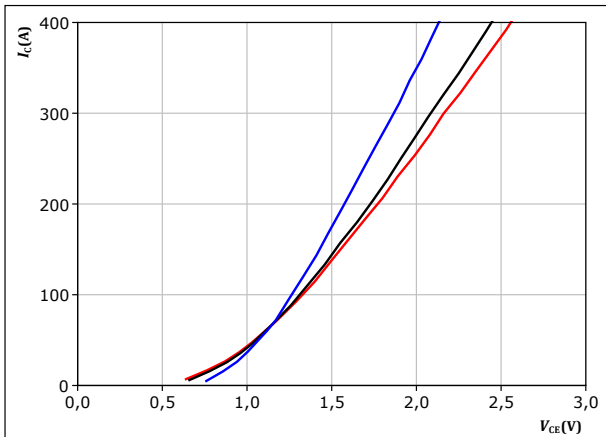


Boost Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

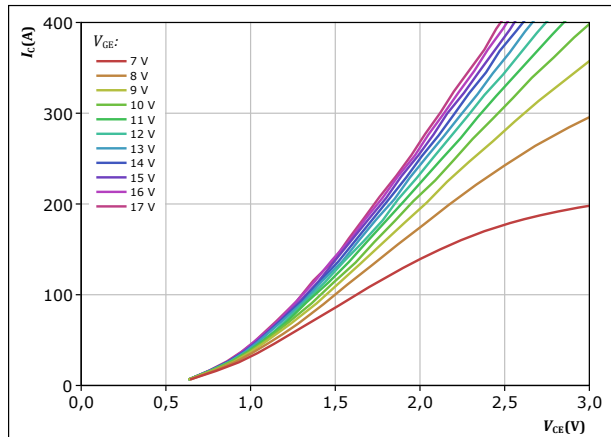


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

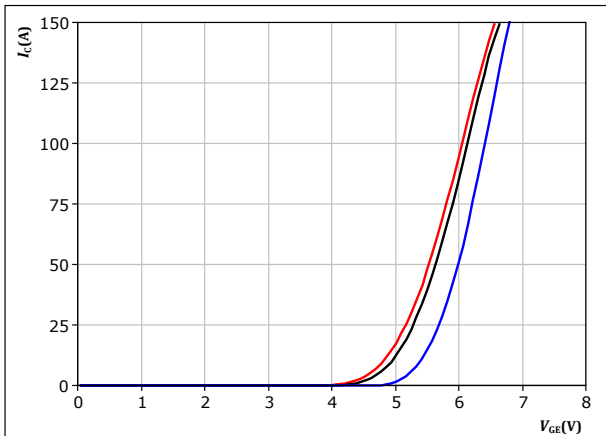


$t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ\text{C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

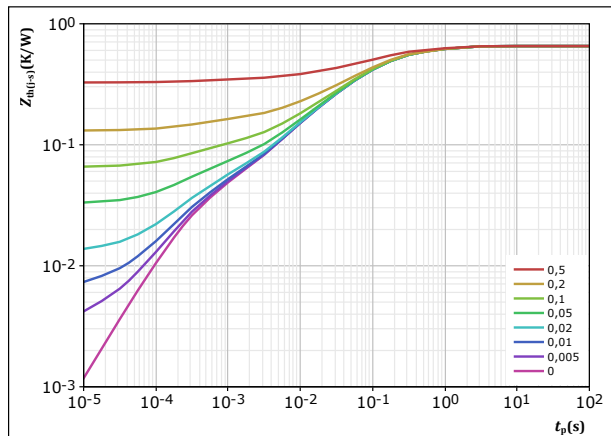


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,654 \text{ K/W}$
IGBT thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 1,13E-01 | 8,46E-01 |
| 2,91E-01 | 1,23E-01 |
| 1,38E-01 | 3,33E-02 |
| 6,68E-02 | 8,32E-03 |
| 1,32E-02 | 2,63E-03 |
| 3,21E-02 | 3,23E-04 |

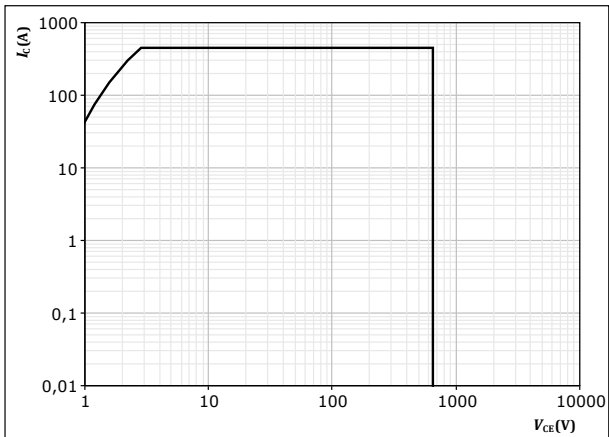


Boost Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse
T_s = 80 °C
V_{CE} = 15 V
T_j = T_{jmax}



Boost Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

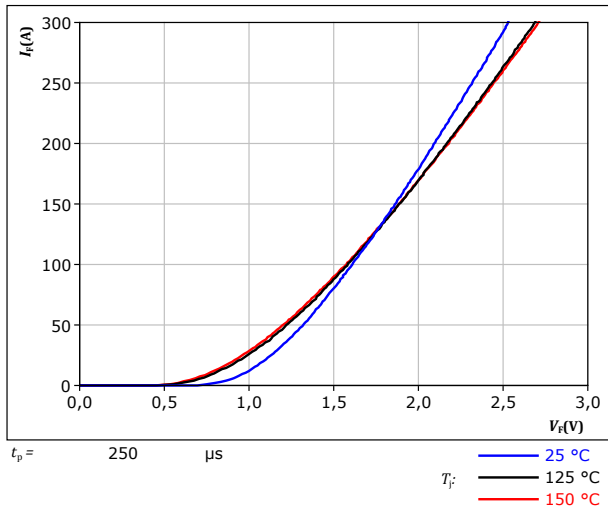
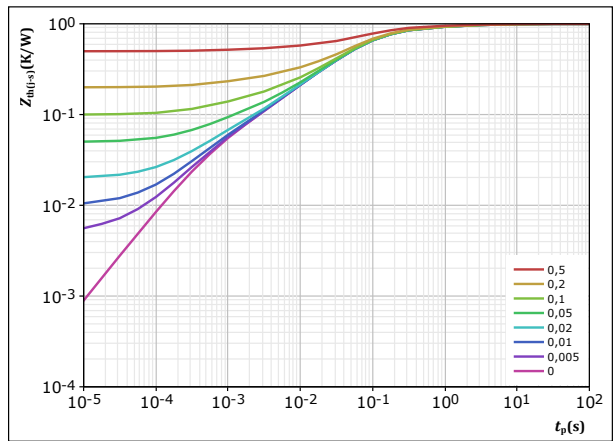


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 0,997 \text{ K/W}$
 FWD thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 4,57E-02 | 5,23E+00 |
| 1,09E-01 | 8,02E-01 |
| 3,92E-01 | 1,26E-01 |
| 3,47E-01 | 3,68E-02 |
| 7,19E-02 | 4,16E-03 |
| 3,26E-02 | 5,44E-04 |

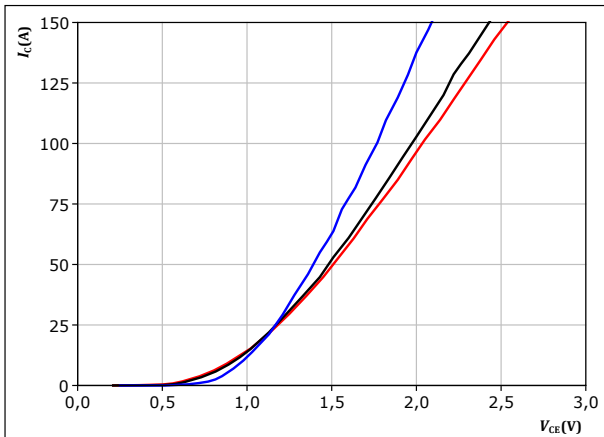


Buck Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

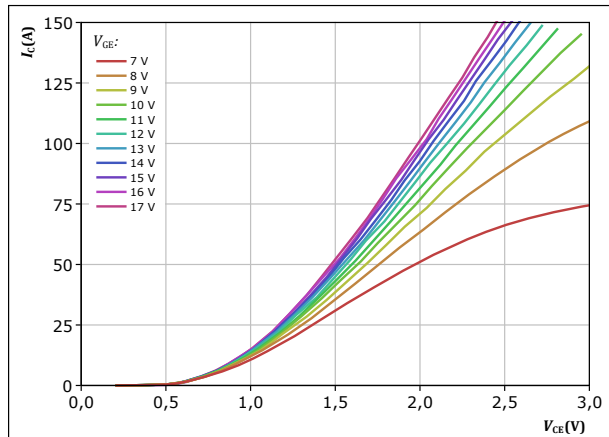


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

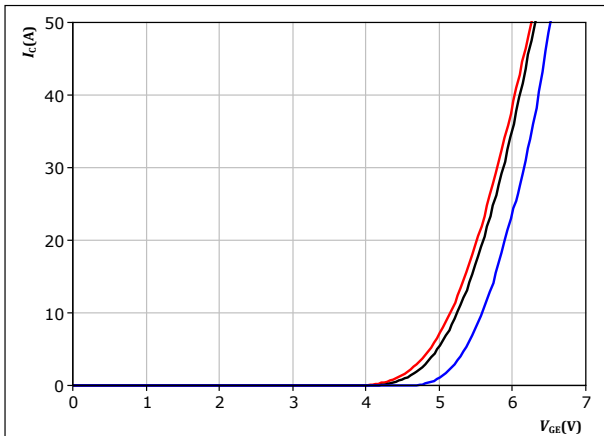


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

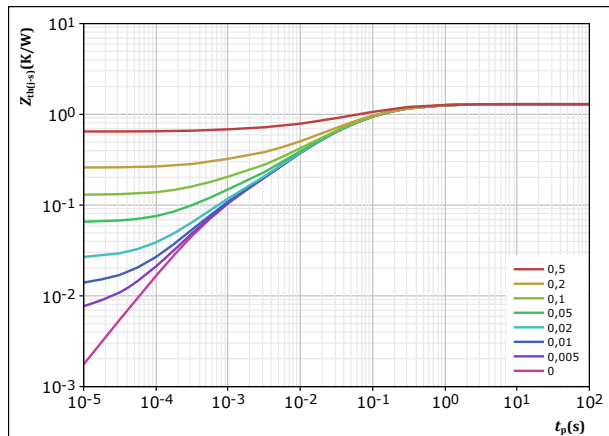


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,294 \text{ K/W}$
IGBT thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 2,09E-01 | 5,36E-01 |
| 6,00E-01 | 8,05E-02 |
| 3,10E-01 | 1,69E-02 |
| 1,08E-01 | 4,25E-03 |
| 6,63E-02 | 5,30E-04 |

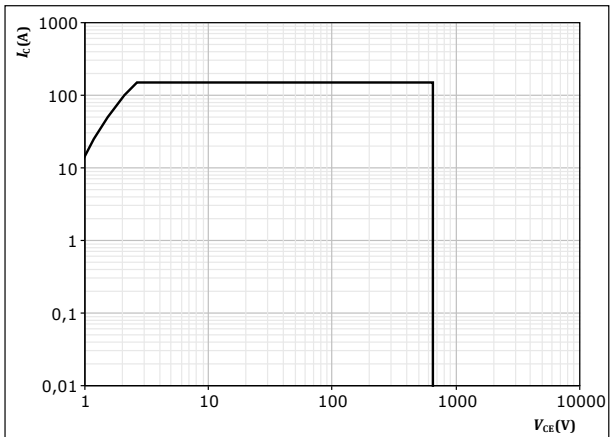


Buck Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse
T_s = 80 °C
V_{CE} = 15 V
T_j = T_{jmax}



Buck Diode Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

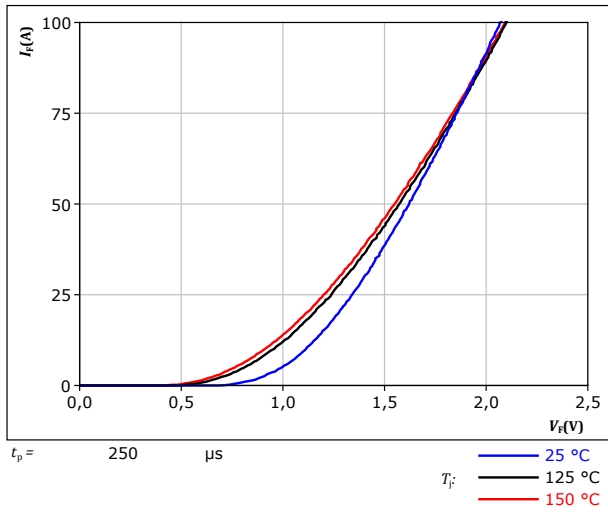
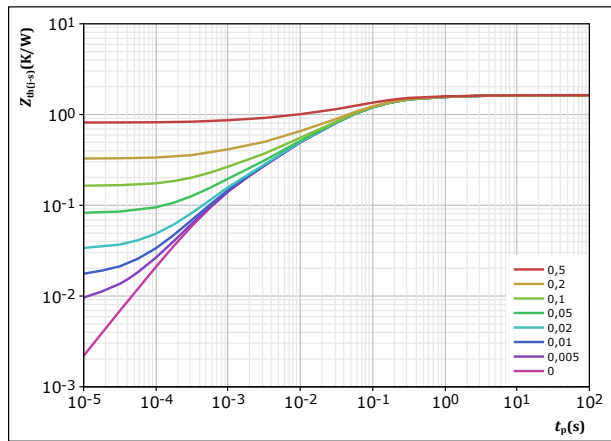


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,634 \text{ K/W}$
 FWD thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 5,48E-02 | 4,24E+00 |
| 1,35E-01 | 6,38E-01 |
| 6,09E-01 | 1,07E-01 |
| 4,79E-01 | 3,28E-02 |
| 2,54E-01 | 5,68E-03 |
| 1,02E-01 | 6,59E-04 |

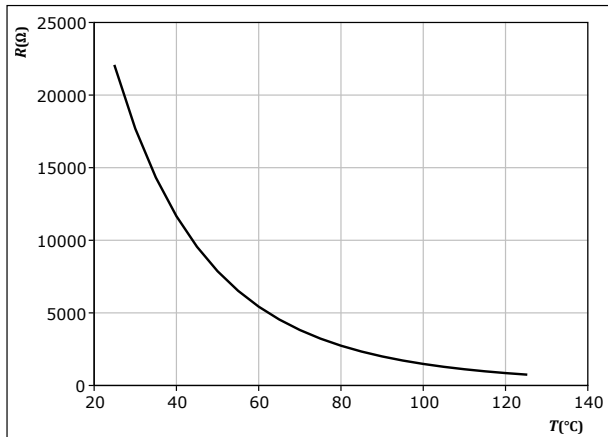


Thermistor Characteristics

figure 15. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

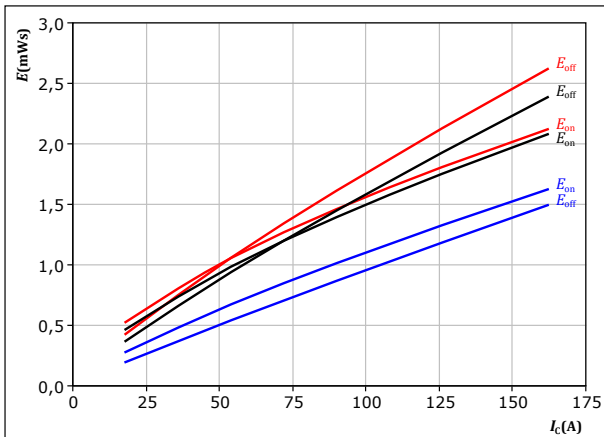




Boost Switching Characteristics

figure 16. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

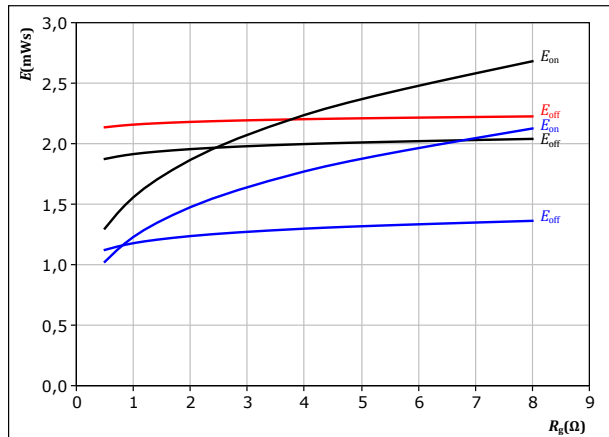


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 2$ Ω
 $R_{g(off)} = 2$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 17. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

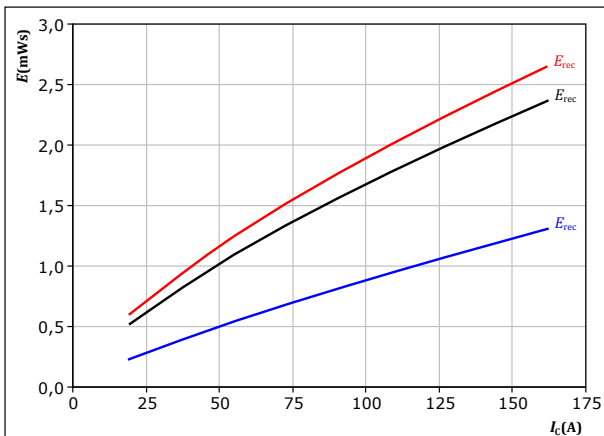


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $I_c = 126$ A

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 18. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

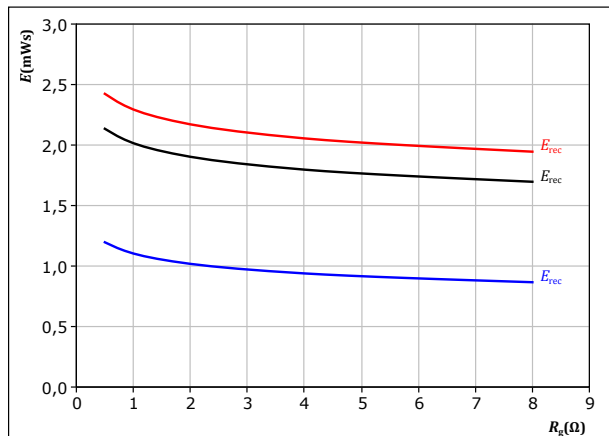


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 2$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 19. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $I_c = 126$ A

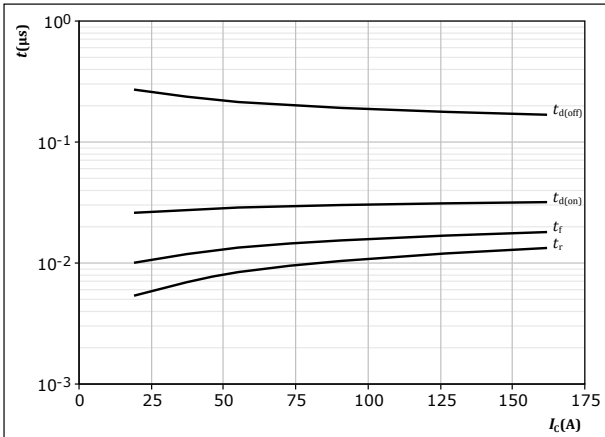
T_j : — 25 °C
 — 125 °C
 — 150 °C



Boost Switching Characteristics

figure 20. IGBT

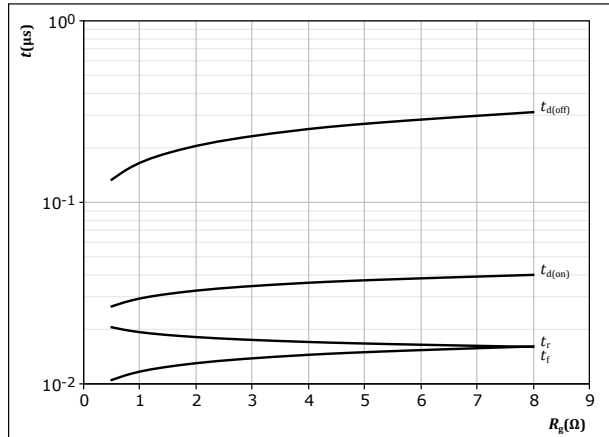
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 21. IGBT

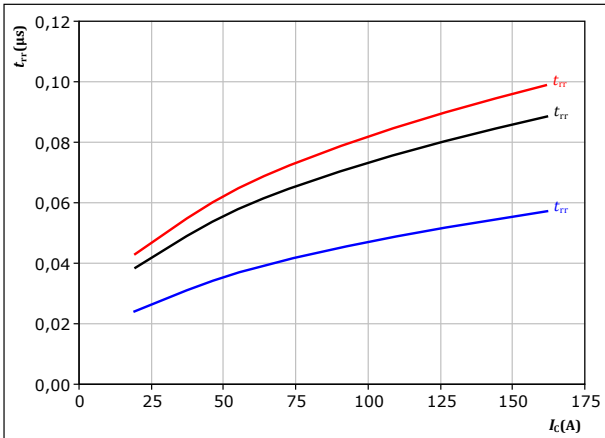
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $I_c = 126$ A

figure 22. FWD

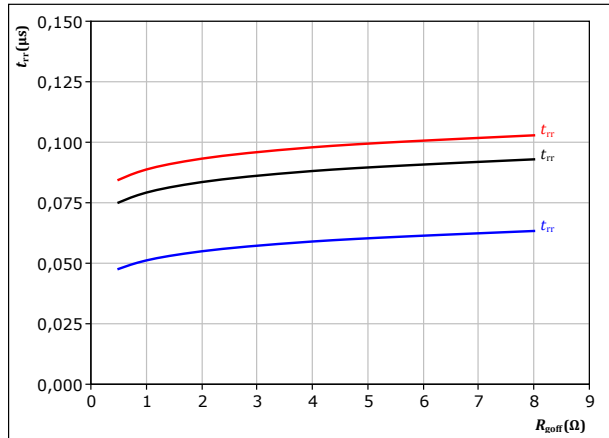
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 2$ Ω
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 23. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $I_c = 126$ A
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

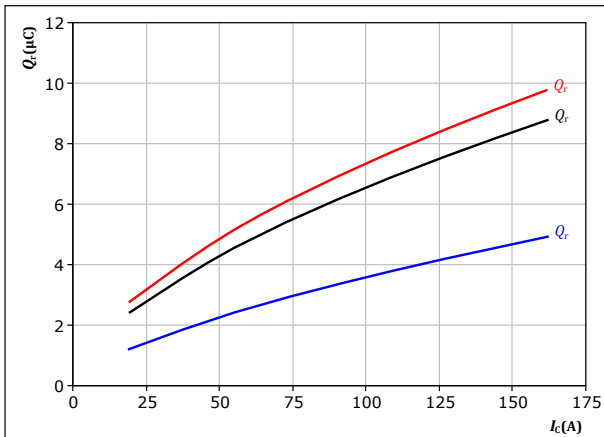


Boost Switching Characteristics

figure 24. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

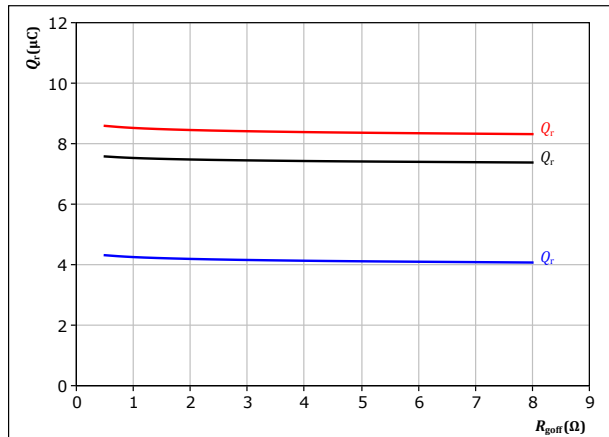
$V_{CE} = 350 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 2 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 25. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

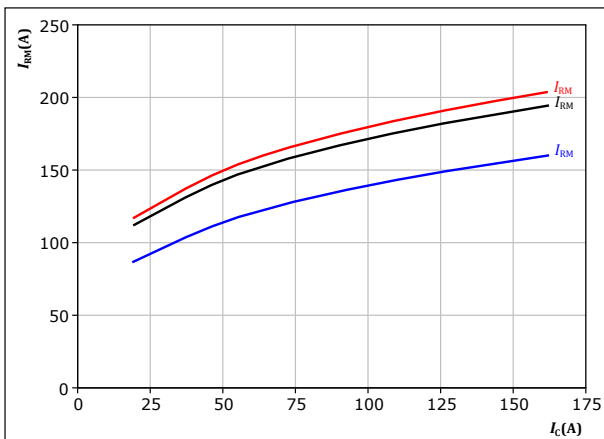
$V_{CE} = 350 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 126 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 26. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

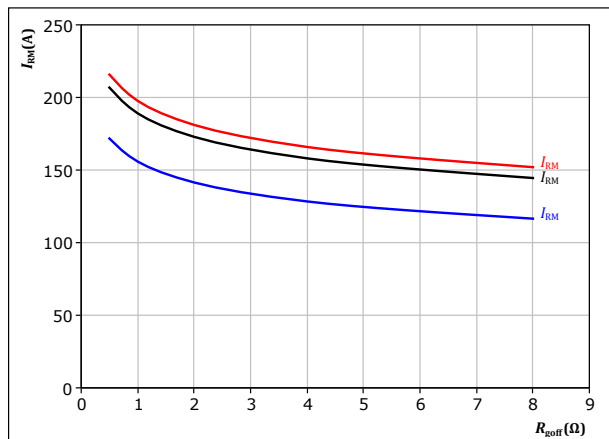
$V_{CE} = 350 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 2 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 27. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 126 \text{ A}$

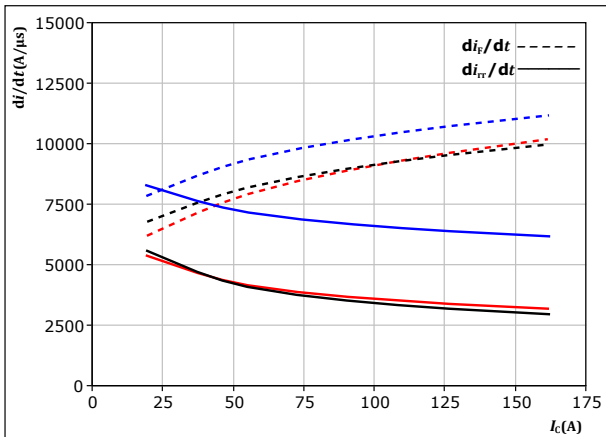
T_j : — 25 °C
— 125 °C
— 150 °C



Boost Switching Characteristics

figure 28. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



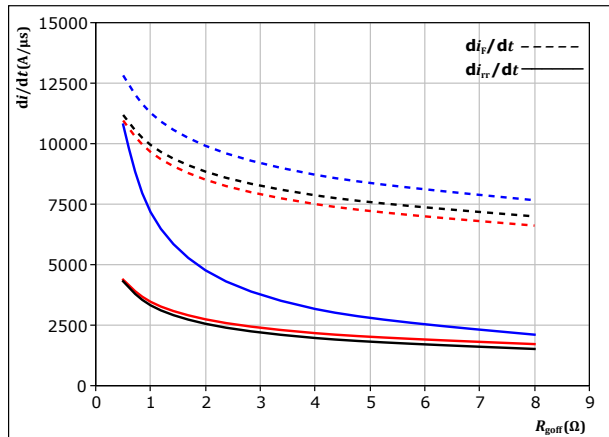
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $R_{goff} = 2$ Ω

$T_j = 25$ °C
 — 125 °C
 — 150 °C

figure 29. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



With an inductive load at

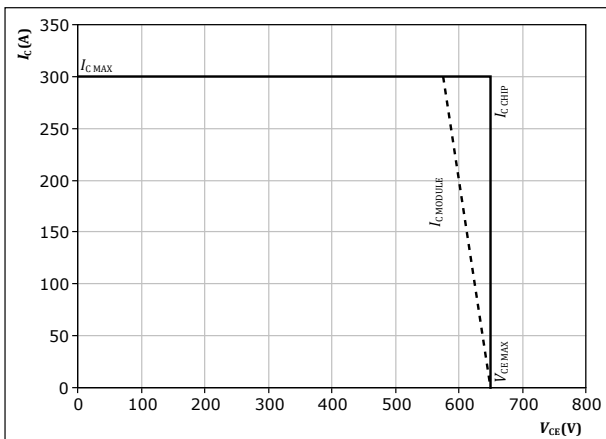
$V_{CE} = 350$ V
 $V_{GE} = 0/15$ V
 $I_c = 126$ A

$T_j = 25$ °C
 — 125 °C
 — 150 °C

figure 30. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



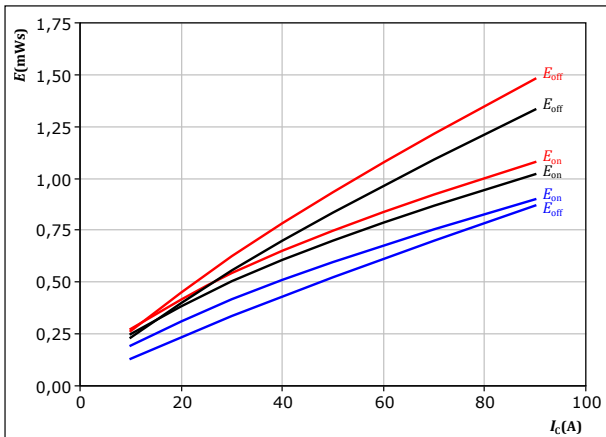
At $T_j = 150$ °C
 $R_{goff} = 2$ Ω
 $R_{goff} = 2$ Ω



Buck Switching Characteristics

figure 31. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

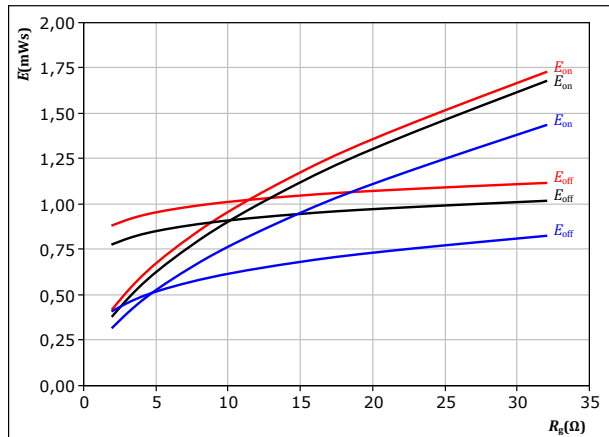


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 32. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

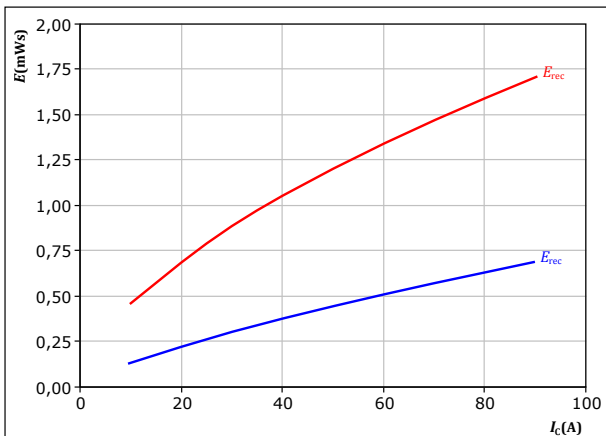


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 33. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

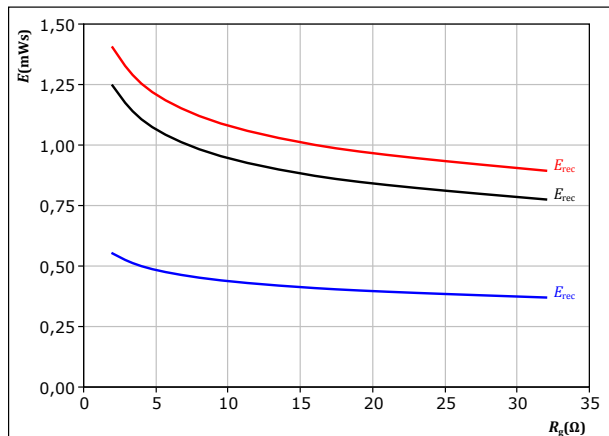


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 8$ Ω

T_j : 25 °C (blue), 150 °C (red)

figure 34. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

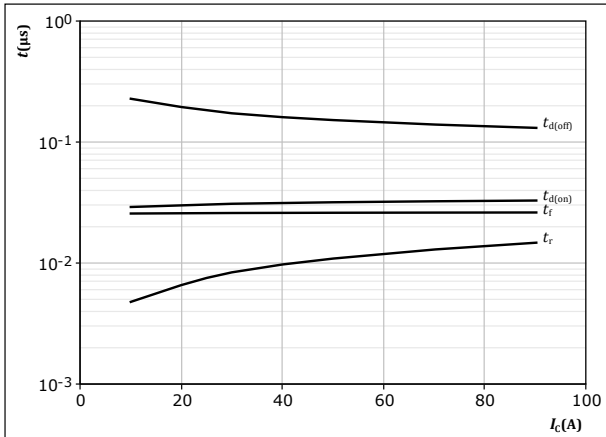
T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Buck Switching Characteristics

figure 35. IGBT

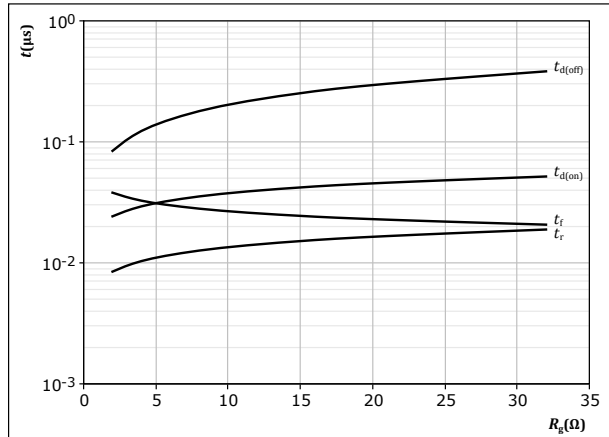
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$
 $R_{g(off)} = 8 \text{ } \Omega$

figure 36. IGBT

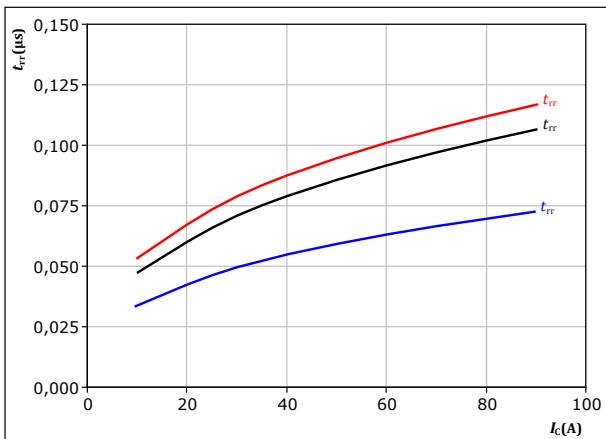
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

figure 37. FWD

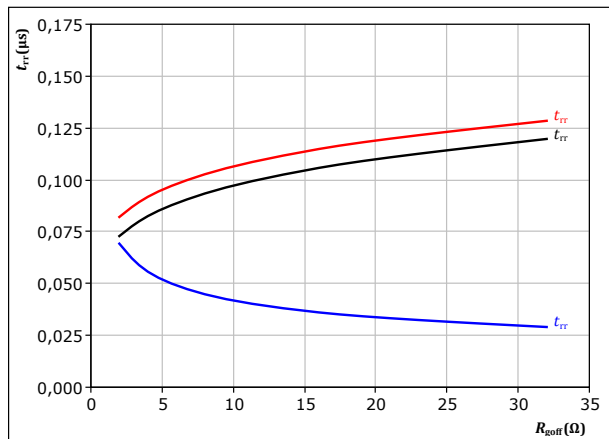
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 38. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

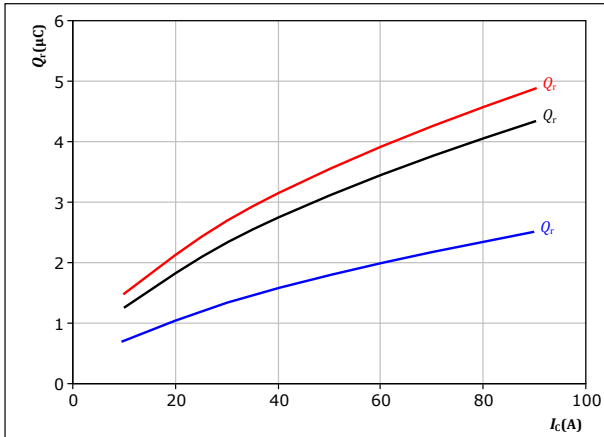


Buck Switching Characteristics

figure 39. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

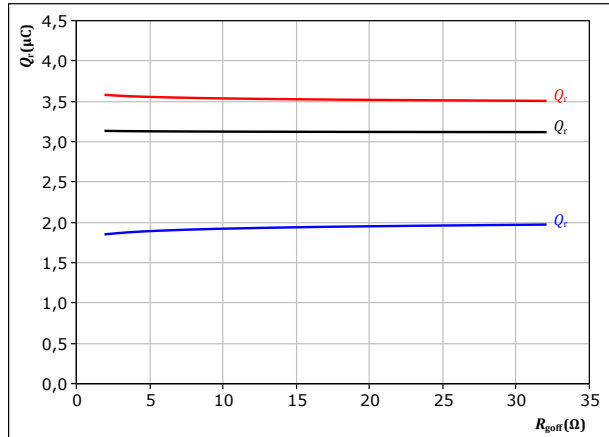
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 40. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

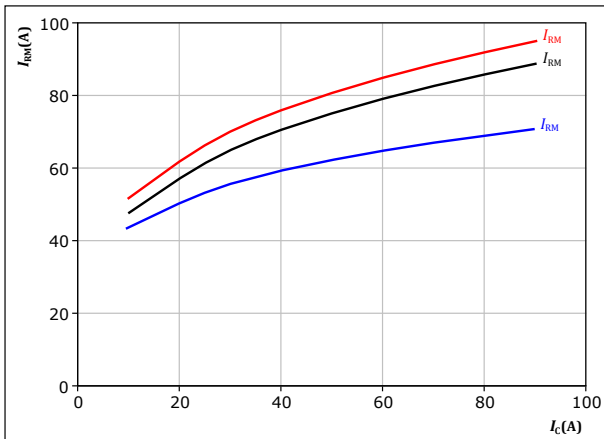
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 41. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

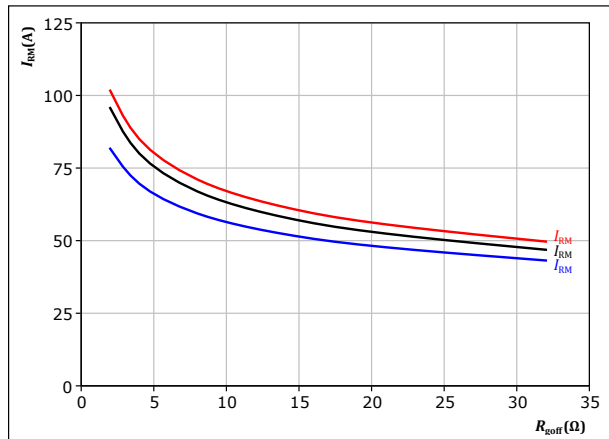
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 42. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 50 \text{ A}$

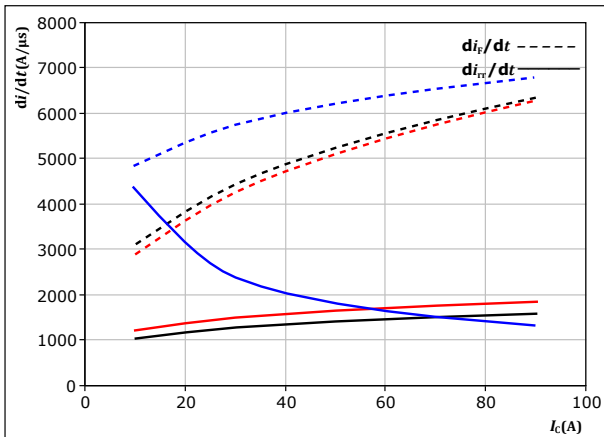
T_j : — 25 °C
— 125 °C
— 150 °C



Buck Switching Characteristics

figure 43. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

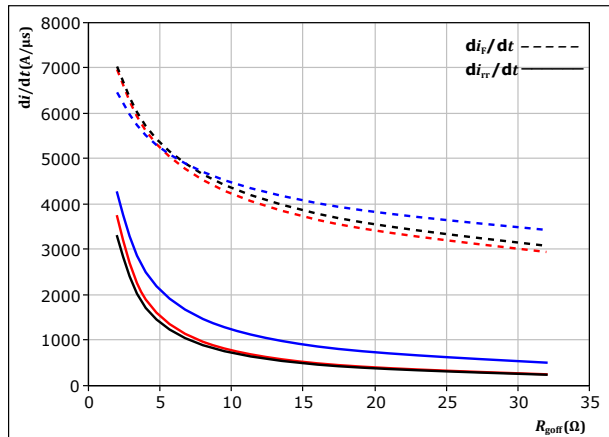


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{goff} = 8$ Ω

Legend:
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 44. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$

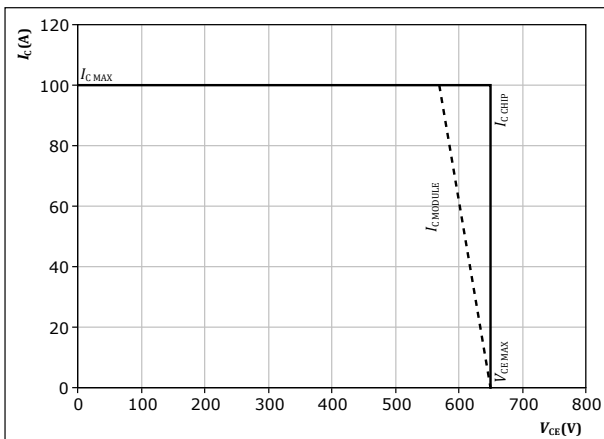


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

Legend:
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 45. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{goff} = 8$ Ω
 $R_{gson} = 8$ Ω



Switching Definitions

figure 46. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

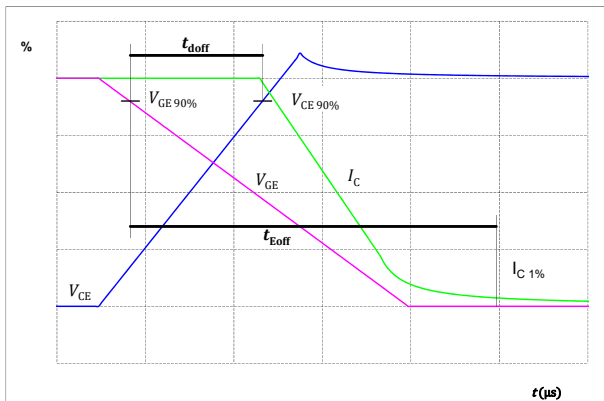


figure 47. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

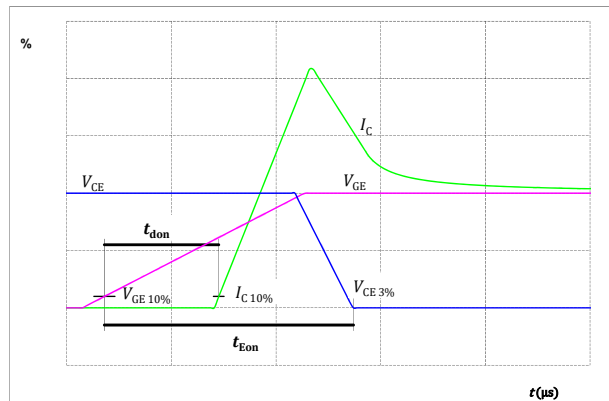


figure 48. IGBT

Turn-off Switching Waveforms & definition of t_f

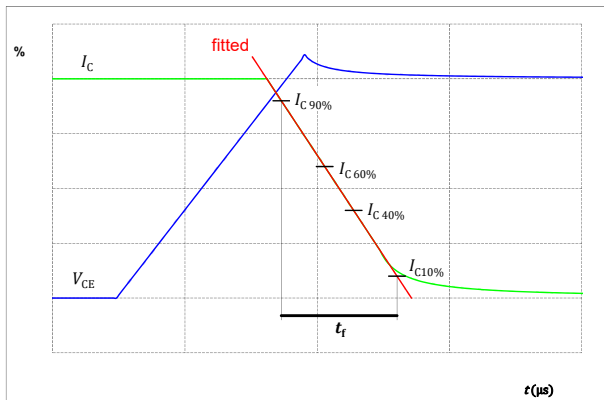
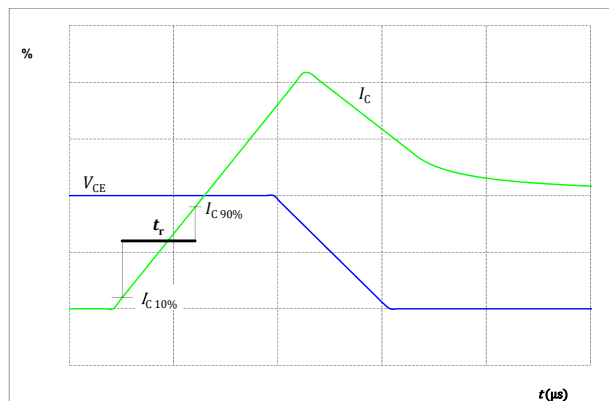


figure 49. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 50. FWD

Turn-off Switching Waveforms & definition of t_{rr}

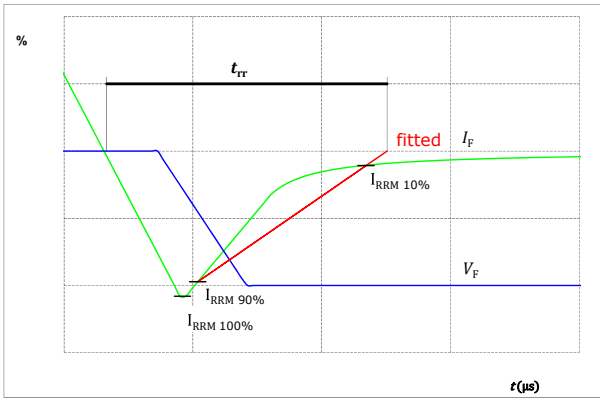
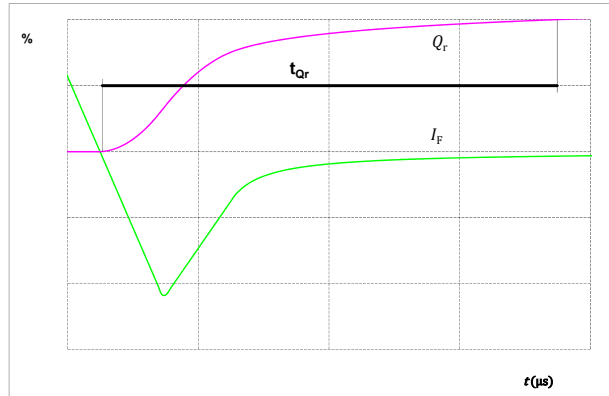


figure 51. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





Vincotech

10-PY07BBA150S5-M735L58Y
datasheet

| Ordering Code | |
|--|------------------------------|
| Version | Ordering Code |
| Without thermal paste | 10-PY07BBA150S5-M735L58Y |
| With thermal paste (5,2 W/mK, PTM6000HV) | 10-PY07BBA150S5-M735L58Y-/7/ |
| With thermal paste (3,4 W/mK, PSX-P7) | 10-PY07BBA150S5-M735L58Y-/3/ |

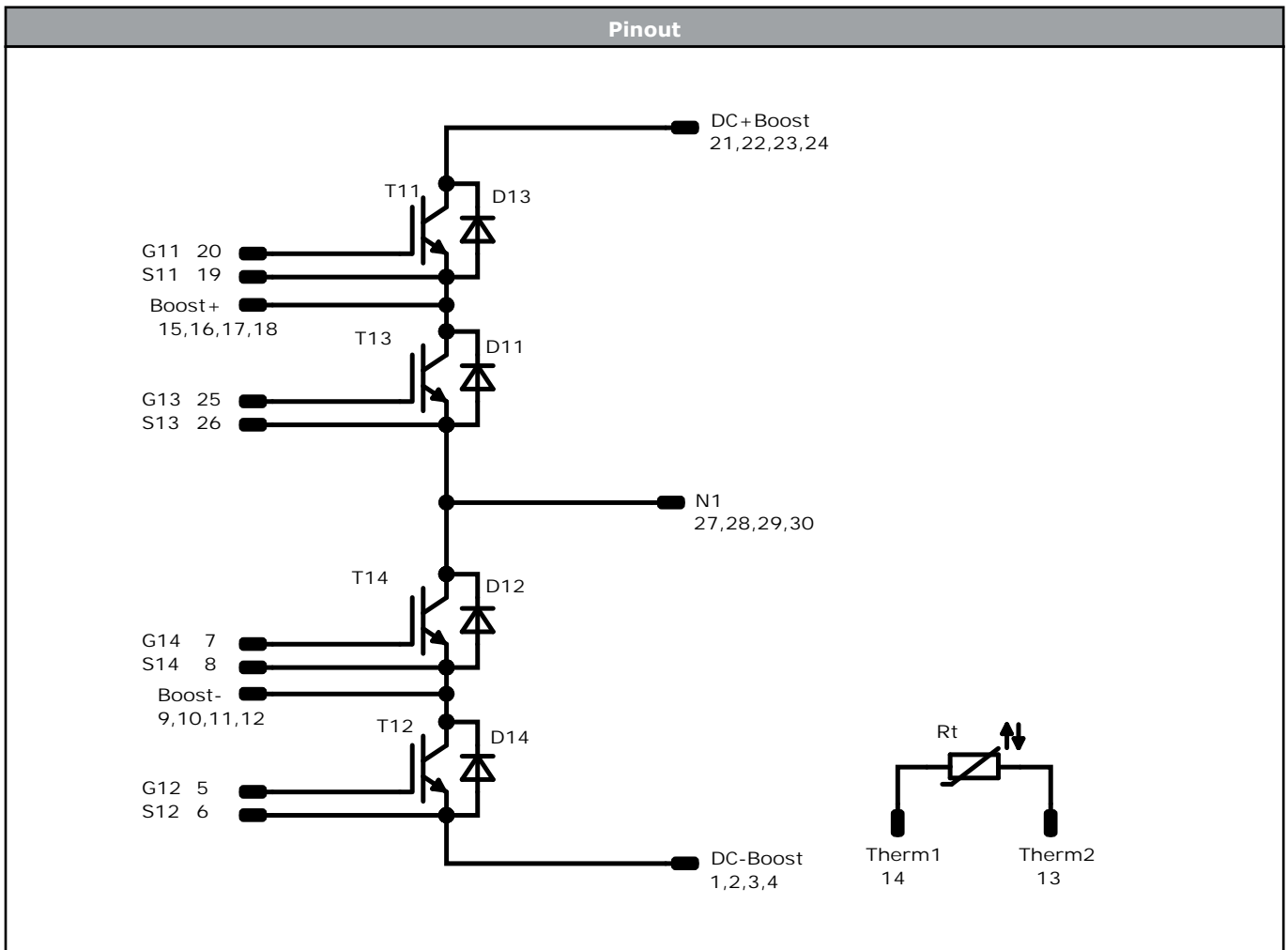
| Marking | | | | | | |
|---------|-------------------|--|----------------------------|-------------------------------|--------------------------|-----------------------|
| | Text | Name NN-NNNNNNNNNNNNNN- TTTTIVV | Date code WWYY | UL & VIN UL VIN | Lot LLLLL | Serial SSSS |
| | Datamatrix | Type&Ver TTTTIVV | Lot number LLLLL | Serial SSSS | Date code WWYY | |

| Pin table [mm] | | | |
|----------------|------|-------|----------|
| Pin | X | Y | Function |
| 1 | 53,1 | 0 | DC-Boost |
| 2 | 53,1 | 3 | DC-Boost |
| 3 | 50,4 | 0 | DC-Boost |
| 4 | 50,4 | 3 | DC-Boost |
| 5 | 47,4 | 0 | G12 |
| 6 | 47,4 | 3 | S12 |
| 7 | 5,7 | 0 | G14 |
| 8 | 5,7 | 3 | S14 |
| 9 | 2,7 | 0 | Boost- |
| 10 | 2,7 | 3 | Boost- |
| 11 | 0 | 0 | Boost- |
| 12 | 0 | 3 | Boost- |
| 13 | 0,4 | 12,95 | Therm2 |
| 14 | 0,4 | 15,95 | Therm1 |
| 15 | 0 | 25,9 | Boost+ |
| 16 | 0 | 28,9 | Boost+ |
| 17 | 2,7 | 25,9 | Boost+ |
| 18 | 2,7 | 28,9 | Boost+ |
| 19 | 5,7 | 25,9 | S11 |
| 20 | 5,7 | 28,9 | G11 |
| 21 | 50,4 | 25,9 | DC+Boost |
| 22 | 50,4 | 28,9 | DC+Boost |
| 23 | 53,1 | 25,9 | DC+Boost |
| 24 | 53,1 | 28,9 | DC+Boost |
| 25 | 4,7 | 12,95 | G13 |
| 26 | 4,7 | 15,95 | S13 |
| 27 | 5,0 | 12,95 | N1 |
| 28 | 5,0 | 15,95 | N1 |
| 29 | 52,7 | 12,95 | N1 |
| 30 | 52,7 | 15,95 | N1 |

Tolerance of pinpositions: ±0.5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech



| Identification | | | | | |
|----------------|-----------|---------|---------|--------------|---------|
| ID | Component | Voltage | Current | Function | Comment |
| T13, T14 | IGBT | 650 V | 150 A | Boost Switch | |
| D13, D14 | FWD | 650 V | 100 A | Boost Diode | |
| T11, T12 | IGBT | 650 V | 50 A | Buck Switch | |
| D11, D12 | FWD | 650 V | 40 A | Buck Diode | |
| Rt | NTC | | | Thermistor | |




Vincotech

| Packaging instruction | | | | |
|---------------------------------------|------|----------|------|--------|
| Standard packaging quantity (SPQ) 100 | >SPQ | Standard | <SPQ | Sample |

| Handling instruction |
|---|
| Handling instructions for <i>flow 1</i> packages see vincotech.com website. |

| Package data |
|--|
| Package data for <i>flow 1</i> packages see vincotech.com website. |

| Vincotech thermistor reference |
|--|
| See Vincotech thermistor reference table at vincotech.com website. |

| UL recognition and file number |
|---|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.: | Date: | Modification: | Pages |
|--------------------------------|--------------|--------------------------------|-------|
| 10-PY07BBA150S5-M735L58Y-D3-14 | 30 Sep. 2021 | Change of Buck diode Rth value | |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.